# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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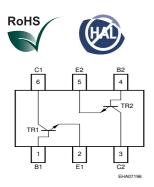
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





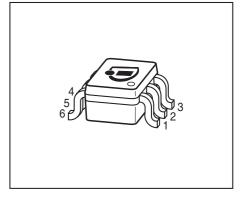
### Low Noise Silicon Bipolar RF Transistor

- For low noise, high-gain broadband amplifiers at collector currents from 0.5 mA to 12 mA
- $f_{\rm T}$  = 8 GHz,  $NF_{\rm min}$  = 0.9 dB at 900 MHz
- Two (galvanic) internal isolated Transistors in one package
- For orientation in reel see package information below
- Easy to use Pb-free (RoHS compliant) and halogen free industry standard package with visible leads
- Qualification report according to AEC-Q101 available



**ESD** (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration					Package	
BFS481	RFs	1=B	2=E	3=C	4=B	5=E	6=C	SOT363



### **BFS481**



Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V <sub>CEO</sub>	12	V	
Collector-emitter voltage	V <sub>CES</sub>	20		
Collector-base voltage	V <sub>CBO</sub>	20		
Emitter-base voltage	V <sub>EBO</sub>	2		
Collector current	I <sub>C</sub>	20	mA	
Base current	I <sub>B</sub>	2		
Total power dissipation <sup>1)</sup>	P <sub>tot</sub>	175	mW	
<i>T</i> <sub>S</sub> ≤ 83 °C				
Junction temperature	TJ	150	°C	
Storage temperature	T <sub>Sta</sub>	-55 150		

### **Maximum Ratings** at $T_A = 25$ °C, unless otherwise specified

#### **Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>2)</sup>	R <sub>thJS</sub>	380	K/W

### **Electrical Characteristics** at $T_A$ = 25 °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					-
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	12	-	-	V
<i>I</i> <sub>C</sub> = 1 mA, <i>I</i> <sub>B</sub> = 0					
Collector-emitter cutoff current	I <sub>CES</sub>	-	-	100	μA
$V_{\rm CE}$ = 20 V, $V_{\rm BE}$ = 0					
Collector-base cutoff current	I <sub>CBO</sub>	-	-	100	nA
$V_{\rm CB}$ = 10 V, $I_{\rm E}$ = 0					
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	1	μA
$V_{\rm EB}$ = 1 V, $I_{\rm C}$ = 0					
DC current gain	h <sub>FE</sub>	70	100	140	-
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, pulse measured					

 $^{1}T_{S}$  is measured on the collector lead at the soldering point of the pcb

<sup>2</sup>For the definition of  $R_{\text{thJS}}$  please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol		Values	1	Unit	
		min.	typ.	max.		
AC Characteristics (verified by random sampling)						
Transition frequency	f <sub>T</sub>	6	8	-	GHz	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $f$ = 500 MHz						
Collector-base capacitance	C <sub>cb</sub>	-	0.23	0.4	pF	
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,						
emitter grounded						
Collector emitter capacitance	C <sub>ce</sub>	-	0.13	-		
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,						
base grounded						
Emitter-base capacitance	C <sub>eb</sub>	-	0.4	-		
V <sub>EB</sub> = 0.5 V, <i>f</i> = 1 MHz, V <sub>CB</sub> = 0 ,						
collector grounded						
Minimum noise figure	NF <sub>min</sub>				dB	
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ ,						
<i>f</i> = 900 MHz		-	0.9	-		
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ ,						
<i>f</i> = 1.8 GHz		-	1.2	-		
Power gain, maximum stable <sup>1)</sup>	G <sub>ms</sub>	-	20	-	dB	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ , $Z_{\rm L}$ = $Z_{\rm Lopt}$ ,						
<i>f</i> = 900 MHz						
Power gain, maximum available <sup>2)</sup>	G <sub>ma</sub>	-	15	-	dB	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ , $Z_{\rm L}$ = $Z_{\rm Lopt}$ ,						
<i>f</i> = 1.8 GHz						
Transducer gain	S <sub>21e</sub>   <sup>2</sup>				dB	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω,						
<i>f</i> = 900 MHz		-	16	-		
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,						
<i>f</i> = 1.8 MHz		-	11	-		

### **Electrical Characteristics** at $T_A = 25$ °C, unless otherwise specified

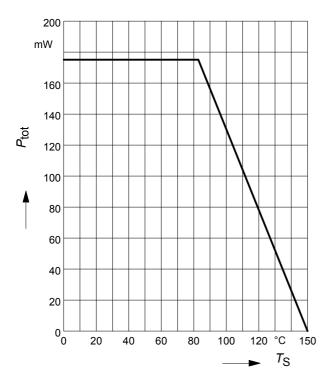
 ${}^{1}G_{\rm ms} = |S_{21} / S_{12}|$  ${}^{2}G_{\rm ma} = |S_{21e} / S_{12e}| \ (k - (k^2 - 1)^{1/2})$ 



**BFS481** 

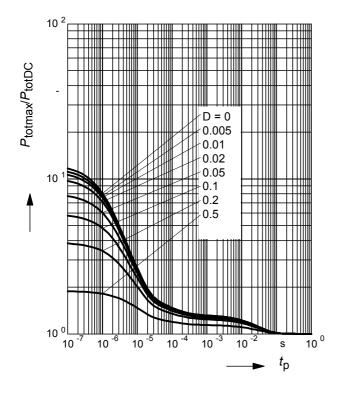
### Total power dissipation $P_{tot} = f(T_S)$

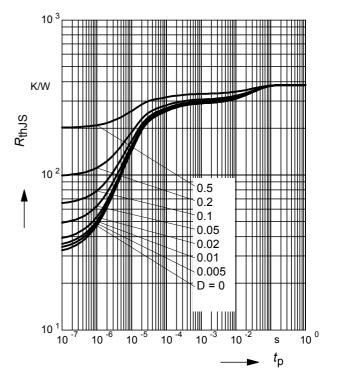
**Permissible Pulse Load**  $R_{\text{thJS}} = f(t_p)$ 



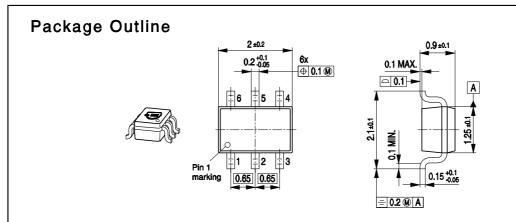
### Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$ 

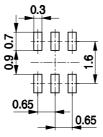






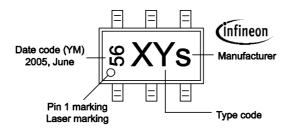


### **Foot Print**



### Marking Layout (Example)

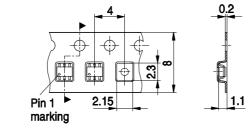
Small variations in positioning of Date code, Type code and Manufacture are possible.



### Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.







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